



# PMEG4005CEA

40 V, 0.5 A low VF MEGA Schottky barrier rectifier

18 November 2016

Product data sheet

## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a very small SOD323 (SC-76) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Average forward current:  $I_{F(AV)} \leq 0.5$  A
- Reverse voltage:  $V_R \leq 40$  V
- Low forward voltage typ.  $V_F = 550$  mV
- Low reverse current typ.  $I_R = 1.5$   $\mu$ A
- Very small SMD plastic package
- AEC-Q101 qualified

## 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Reverse polarity protection
- Low power consumption applications
- Automotive applications

## 4. Quick reference data

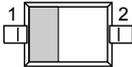
Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; $T_{sp} \leq 135$ °C; square wave	-	-	0.5	A
$V_R$	reverse voltage	$T_j = 25$ °C	-	-	40	V
$V_F$	forward voltage	$I_F = 500$ mA; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_j = 25$ °C	-	550	640	mV
$I_R$	reverse current	$V_R = 40$ V; $T_j = 25$ °C; pulsed	[1]	1.5	8	$\mu$ A
		$V_R = 40$ V; $T_j = 125$ °C; pulsed	[1]	1	8	mA

[1] Very short test pulse to keep junction temperature unchanged.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 SOD323	 <i>sym001</i>
2	A	anode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG4005CEA	SOD323	plastic surface-mounted package; 2 leads	SOD323

## 7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG4005CEA	EC

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	$T_j = 25\text{ °C}$		-	40	V
$I_F$	forward current	$T_{sp} \leq 130\text{ °C}; \delta = 1$		-	0.5	A
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20\text{ kHz}; T_{sp} \leq 135\text{ °C}$ ; square wave		-	0.5	A
$I_{FRM}$	repetitive peak forward current	$t_p \leq 1\text{ ms}; \delta \leq 0.25$		-	2	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8\text{ ms}; T_{j(\text{init})} = 25\text{ °C}$ ; square wave		-	8	A
$P_{\text{tot}}$	total power dissipation	$T_{\text{amb}} \leq 25\text{ °C}$	[1]	-	380	mW
			[2]	-	555	mW
$T_j$	junction temperature			-	150	°C
$T_{\text{amb}}$	ambient temperature			-55	150	°C
$T_{\text{stg}}$	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode  $1\text{ cm}^2$ .

## 9. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{\text{th}(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	330	K/W
			[1] [3]	-	-	225	K/W
$R_{\text{th}(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	45	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode  $1\text{ cm}^2$ .

[4] Soldering point of cathode tab.

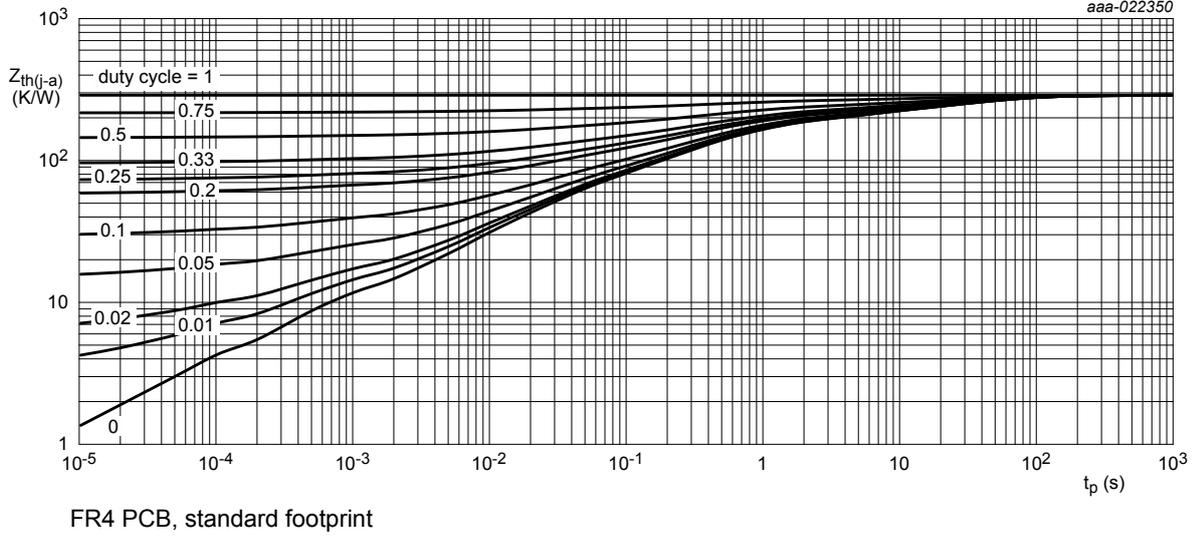


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

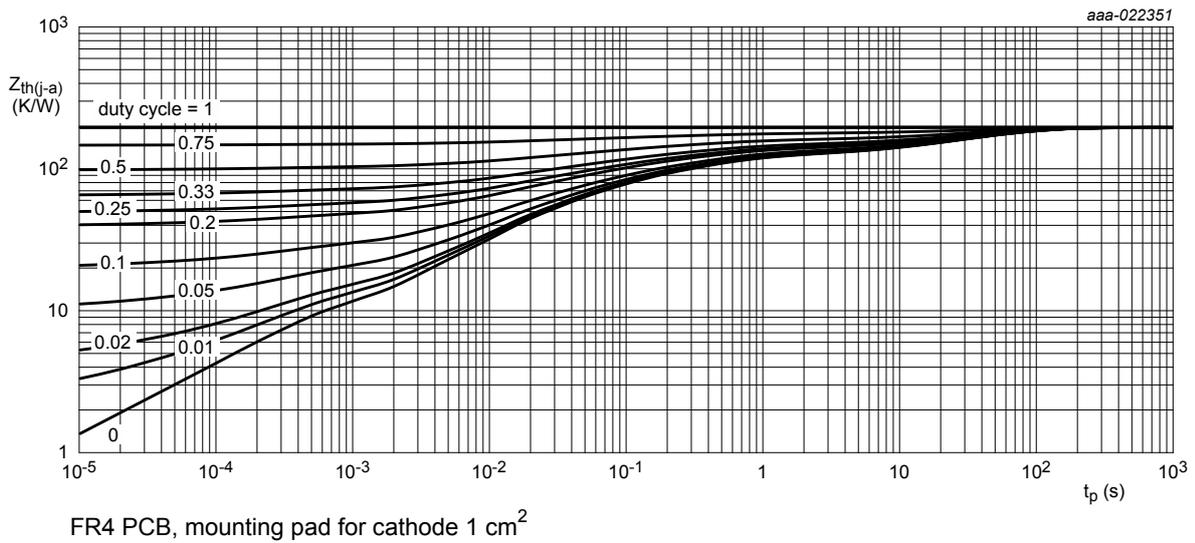


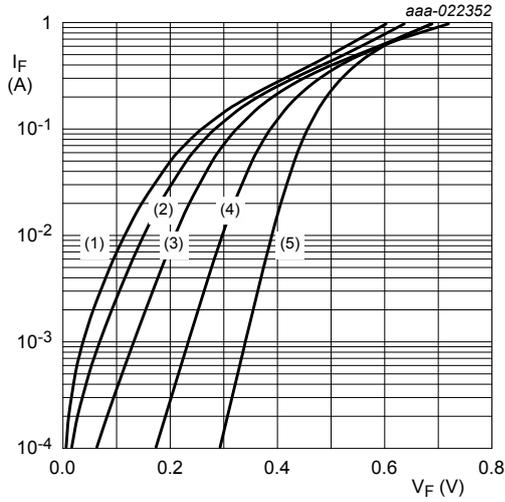
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

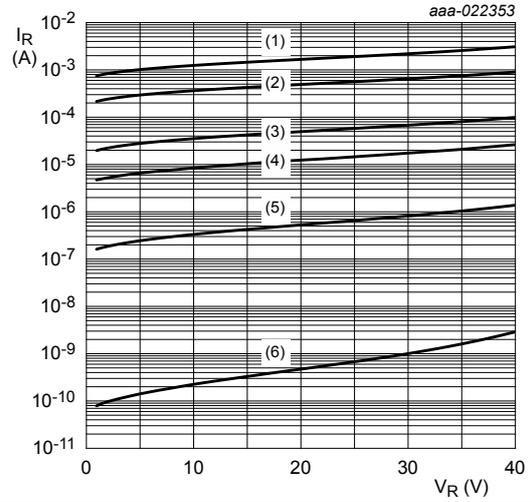
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 1 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	40	-	-	V
$V_F$	forward voltage	$I_F = 10 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	300	380	mV
		$I_F = 100 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	390	470	mV
		$I_F = 200 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	435	510	mV
		$I_F = 300 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	515	600	mV
		$I_F = 400 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	515	600	mV
		$I_F = 500 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	550	640	mV
		$I_F = 500 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = -40 \text{ } ^\circ\text{C}$	-	570	670	mV
		$I_F = 500 \text{ mA}$ ; $t_p \leq 300 \text{ } \mu\text{s}$ ; $\delta \leq 0.02$ ; $T_j = 125 \text{ } ^\circ\text{C}$	-	520	610	mV
$I_R$	reverse current	$V_R = 30 \text{ V}$ ; $T_j = 25 \text{ } ^\circ\text{C}$ ; pulsed [1]	-	1	5	$\mu\text{A}$
		$V_R = 40 \text{ V}$ ; $T_j = 25 \text{ } ^\circ\text{C}$ ; pulsed [1]	-	1.5	8	$\mu\text{A}$
		$V_R = 40 \text{ V}$ ; $T_j = 125 \text{ } ^\circ\text{C}$ ; pulsed [1]	-	1	8	mA
$C_d$	diode capacitance	$V_R = 1 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	24	-	pF
		$V_R = 4 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	13.5	-	pF
		$V_R = 10 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	9	-	pF
$t_{rr}$	reverse recovery time	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(\text{meas})} = 0.1 \text{ A}$ ; $T_j = 25 \text{ } ^\circ\text{C}$	-	1.8	-	ns

[1] Very short test pulse to keep junction temperature unchanged.



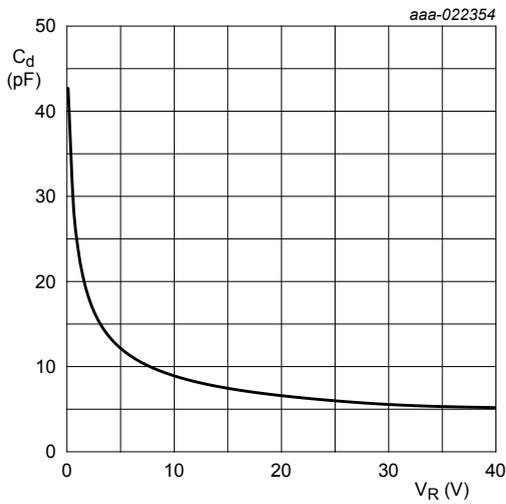
pulsed condition  
 (1)  $T_j = 150\text{ }^\circ\text{C}$   
 (2)  $T_j = 125\text{ }^\circ\text{C}$   
 (3)  $T_j = 85\text{ }^\circ\text{C}$   
 (4)  $T_j = 25\text{ }^\circ\text{C}$   
 (5)  $T_j = -40\text{ }^\circ\text{C}$

**Fig. 3. Forward current as a function of forward voltage; typical values**



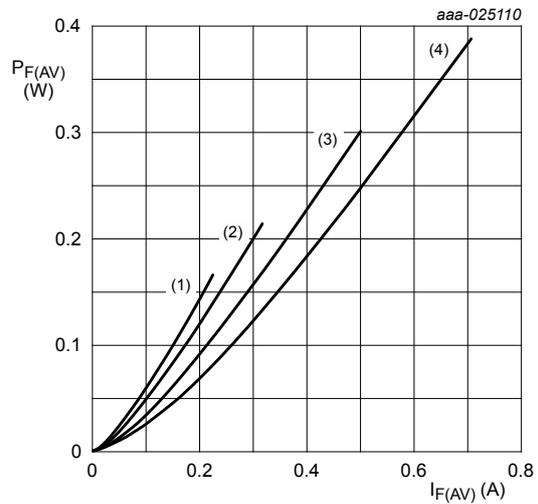
pulsed condition  
 (1)  $T_j = 150\text{ }^\circ\text{C}$   
 (2)  $T_j = 125\text{ }^\circ\text{C}$   
 (3)  $T_j = 85\text{ }^\circ\text{C}$   
 (4)  $T_j = 65\text{ }^\circ\text{C}$   
 (5)  $T_j = 25\text{ }^\circ\text{C}$   
 (6)  $T_j = -40\text{ }^\circ\text{C}$

**Fig. 4. Reverse current as a function of reverse voltage; typical values**



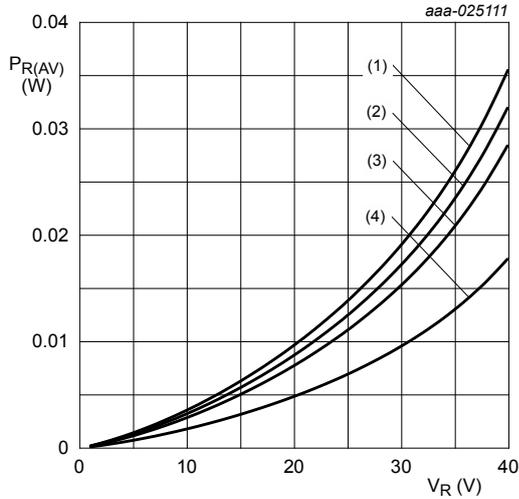
$f = 1\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

**Fig. 5. Diode capacitance as a function of reverse voltage; typical values**



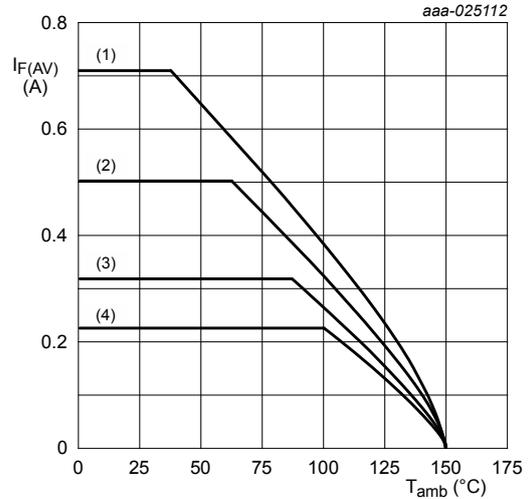
$T_j = 150\text{ }^\circ\text{C}$   
 (1)  $\delta = 0.1$   
 (2)  $\delta = 0.2$   
 (3)  $\delta = 0.5$   
 (4)  $\delta = 1\text{ (DC)}$

**Fig. 6. Average forward power dissipation as a function of average forward current; typical values**



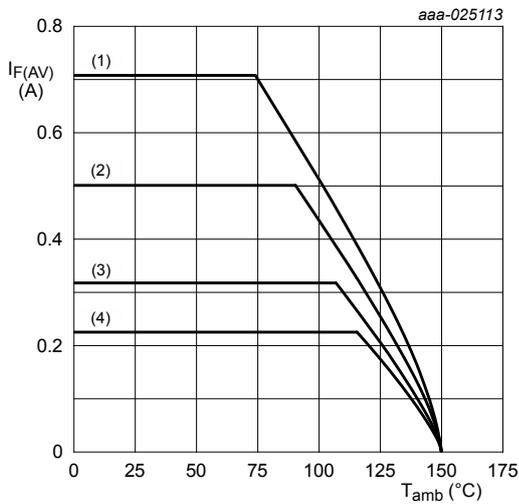
$T_j = 125\text{ °C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.9$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.8$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$

**Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values**



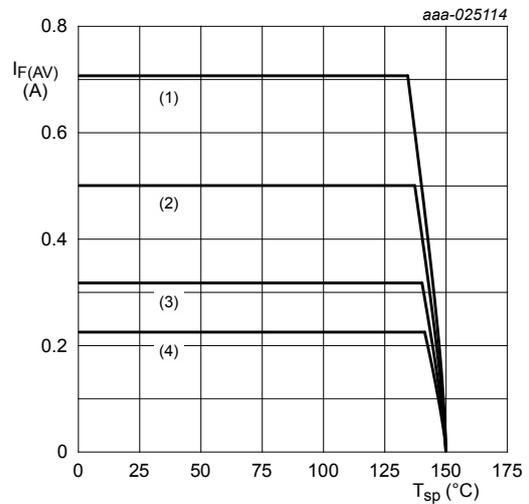
FR4 PCB, standard footprint  
 $T_j = 150\text{ °C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 8. Average forward current as a function of ambient temperature; typical values**



FR4 PCB, mounting pad for cathode  $1\text{ cm}^2$   
 $T_j = 150\text{ °C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 9. Average forward current as a function of ambient temperature; typical values**



$T_j = 150\text{ °C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.2$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.1$ ;  $f = 20\text{ kHz}$

**Fig. 10. Average forward current as a function of solder point temperature; typical values**

### 11. Test information

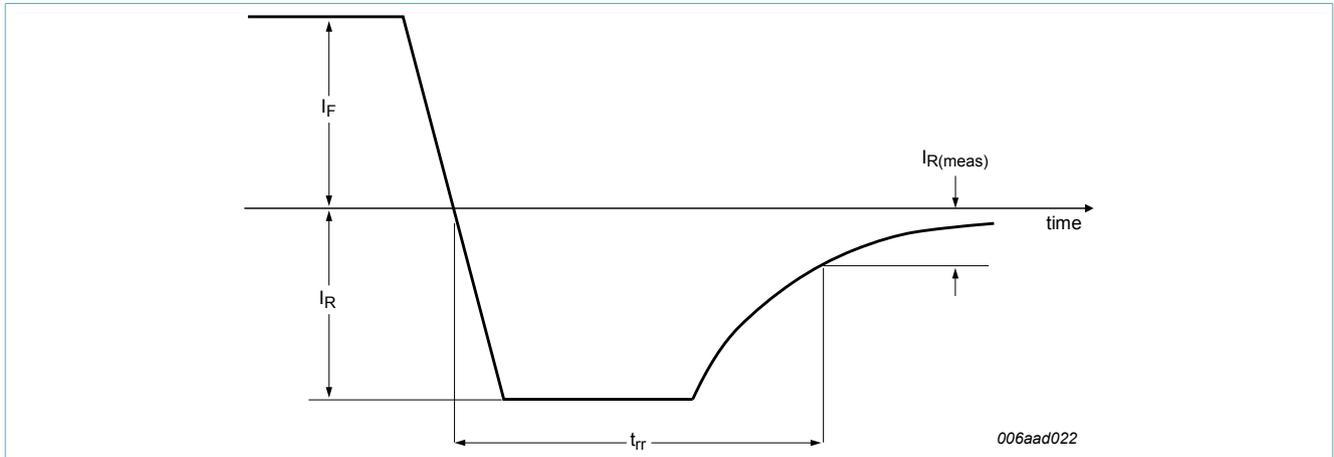


Fig. 11. Reverse recovery definition

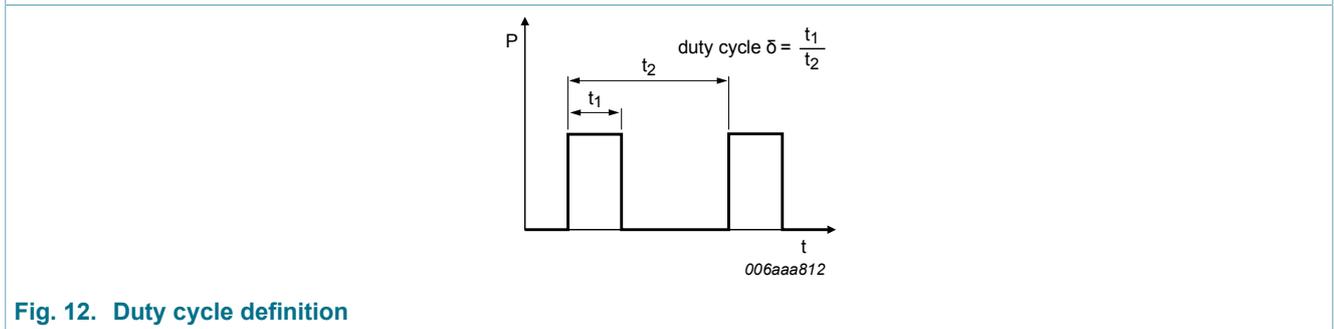


Fig. 12. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

#### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline

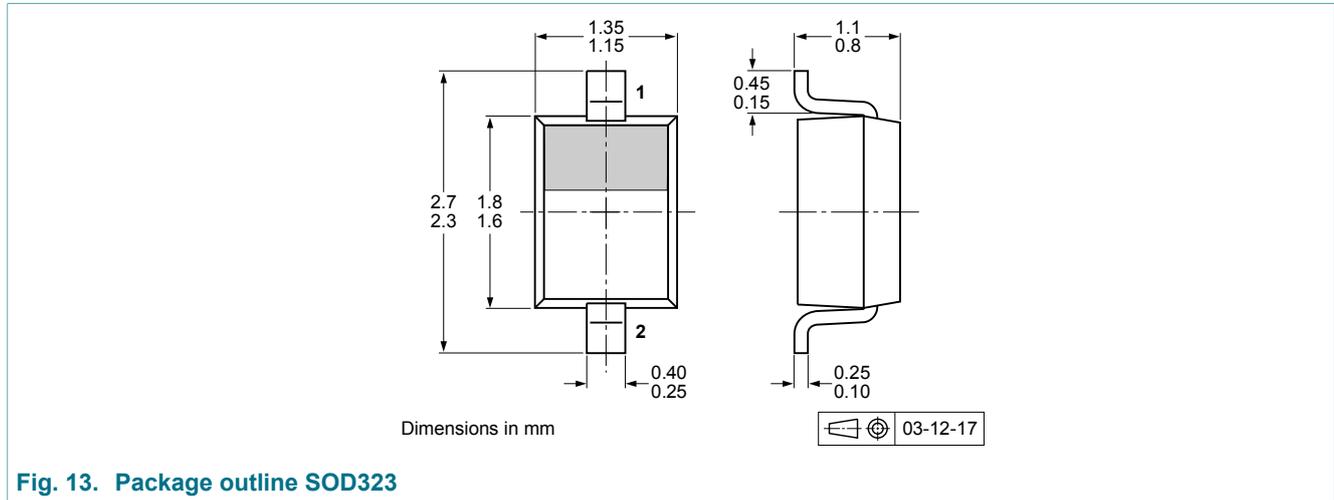


Fig. 13. Package outline SOD323

## 13. Soldering

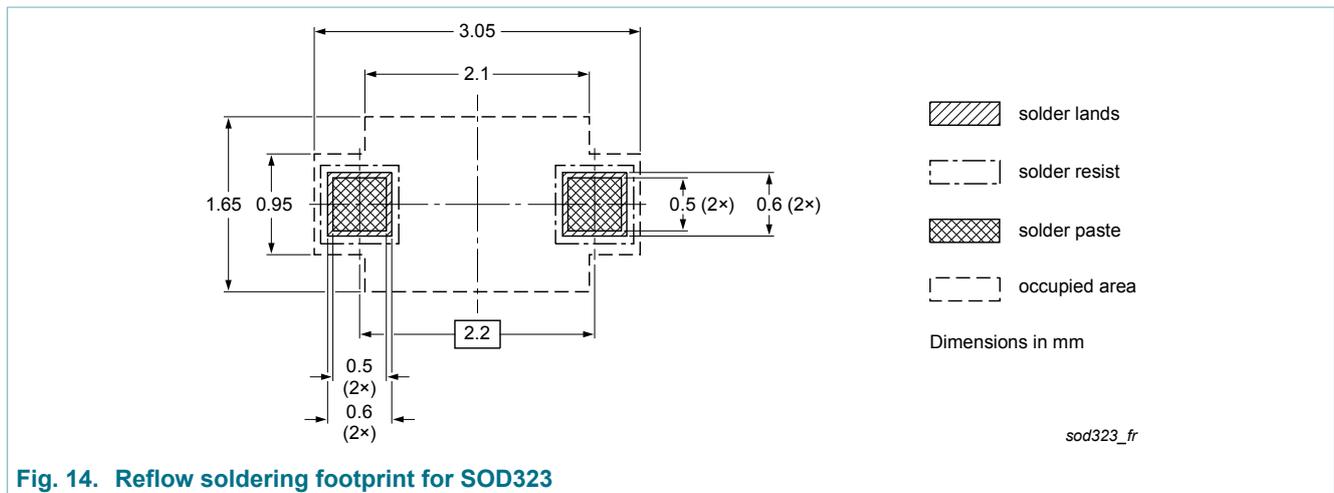


Fig. 14. Reflow soldering footprint for SOD323

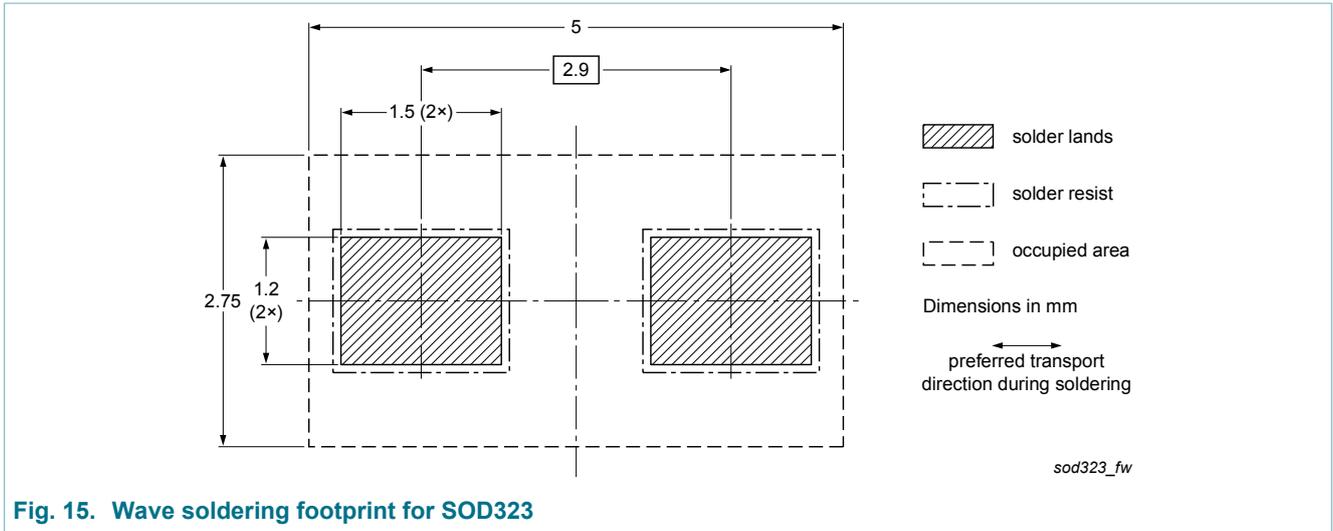


Fig. 15. Wave soldering footprint for SOD323

## 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG4005CEA v.1	20161118	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status <sup>[1]</sup> <sup>[2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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